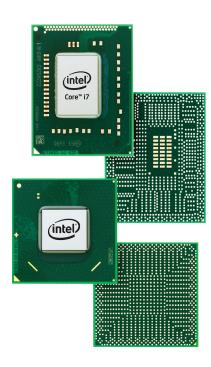
## PLATFORM BRIEF

Intel® Core™ i7 and Core™ i5 processors with Intel® QM67 Express and Intel® HM65 Express Chipsets

**Embedded Computing** 



# 2<sup>nd</sup> Generation Intel® Core™ i7 (2710QE, 2715QE) and Intel® Core™ i5 (2510E, 2515E) Processor-based Platforms for Embedded Computing



### **Product Overview**

These Intel® Core™ i7 and Intel® Core™ i5 processors are based on the 2<sup>nd</sup> generation Intel® Core™ microarchitecture on 32nm process technology, featuring new levels of performance for embedded, computeintensive applications along with advanced features for remote management capabilities and reliability. When paired with the Intel® QM67 Express or Intel® HM65 Express chipset, these two-chip platforms provide excellent media, graphics, and I/O flexibility, stunning and seamless visual experiences, as well as error correcting code (ECC) memory<sup>1</sup>. These platforms meet the requirements of a broad range of embedded applications, including retail and transaction solutions, signage, gaming platforms, industrial automation and medical equipment.

Processors offer quad-core and dual-core processing with industry-leading performance capabilities. While incorporating advanced technology, they remain software-compatible with previous IA-32 processors.

The next-generation graphics engine, Intel® HD Graphics 3000, doubles graphics performance compared with previous Intel® Core™ processor-based platforms. Full integration of the CPU, media/graphics capabilities and memory controller reduces overall platform footprint and provides faster performance as well as board real estate savings. Additionally, developers can create one board design and scale their product line between quad- and dual-core processors using the same socket. Thermal design power (TDP) options are 35W and 45W.

# **Product Highlights**

Intel® HD Graphics 3000: Supports highend enhanced media/graphics capabilities and performance while reducing overall platform power requirements.

Intel® Advanced Vector Extensions: Accelerates floating-point compute performance for signal and image processing applications.

Intel® Quick Sync Video: Improves media/video performance and frees up the CPU for other tasks.

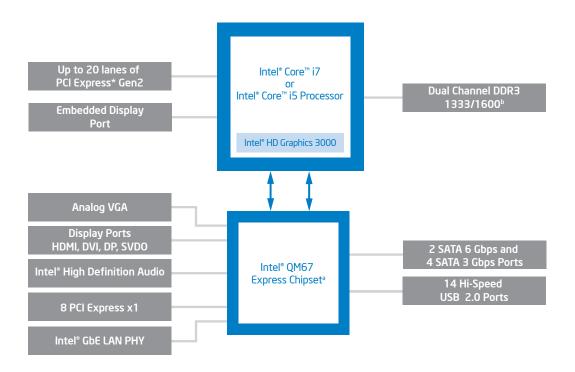
**ECC**<sup>1</sup>: Provides a high level of data integrity, reliability, and system uptime (select SKUs).

Intel® Intelligent Power Technology<sup>2</sup>: Reduces idle power consumption through architectural improvements such as integrated power gates and automated low-power states.

**Intel® Turbo Boost Technology**<sup>3</sup> **2.0:** Runs applications faster by using available thermal headroom to run at a higher frequency.

Intel® Hyper-Threading Technology4: Simultaneous multi-threading helps boost performance for parallel, multi-threaded applications.

Intel® vPro™ Technology<sup>5</sup>: When paired with the Intel QM67 Express chipset, this platform delivers unprecedented hardware support for vital security and management functions utilizing Intel® Virtualization Technology, Intel® Active Management Technology, and Intel® Trusted Execution Technology.



<sup>a</sup>Intel<sup>®</sup> HM65 Express chipset also available with a subset of features. <sup>b</sup>All SKUs support 1333 MT/s, 1 DIMM per channel (1 DPC); the PGA 4-core SKU supports 1333 MT/s, 2 DIMMs per channel (2 DPC); the PGA 4-core SKU also supports 1600 MT/s but only with 1 DIMM per channel (1DPC).

# **Software Overview**

The following independent operating system and BIOS vendors provide support for these platforms.

OPERATING SYSTEM	CONTACT	BIOS
Microsoft Windows* 7	Intel provides drivers9	Ame
Microsoft Windows* XP SP3	Intel provides drivers9	Insy
Microsoft Windows Embedded Standard 7	Intel provides drivers9	Phoe
Microsoft Windows Embedded Standard 2009	Intel provides drivers9	Byos
Microsoft Windows Embedded POSReady (WEPOS)	Intel provides drivers9	
Red Hat Enterprise Linux* 6.1	Red Hat	
SUSE SLE* 11 SP1	Novell	
Wind River Linux* 3.0	Wind River	
Wind River VxWorks* 6.8	Wind River	

nerican Megatrends yde Software oenix Technologies osoft

FEATURES	BENEFITS
Supports key embedded platform requirements	Ideal for compute-intensive embedded applications.
Extended life cycle product support	Protects system investment by enabling extended product availability for embedded customers.
Embedded ecosystem support	Along with a strong ecosystem of hardware and software vendors, including members of the Intel® Embedded Alliance (intel.com/go/embeddedalliance), Intel helps to cost-effectively meet development challenges and speed time-to-market.
Intel® Advanced Vector Extensions	Enables faster performance on digital signal image and digital signal processing workloads for compute-intensive applications such as radar detection, hurricane command center, ruggedized navigation systems and remote medical image processing.
Intel® Turbo Boost Technology³ 2.0	Boosts performance for specific workloads by increasing processor frequency.
Intel® HD Graphics 3000	Excellent 3D performance for a broad range of embedded applications with support for dual LVDS and hybrid multi-monitor configurations.
Intel® Hyper-Threading Technology <sup>4</sup>	Enables simultaneous multi-threading within each processor core, up to two threads per core; reduces computational latency, making optimal use of every clock cycle.
Intel® Smart Cache Technology	Large on-die shared Last-Level Cache reduces latency to data, improving performance and power efficiency.

Platform Features and Benefits

3 1 11			
Embedded ecosystem support	Along with a strong ecosystem of hardware and software vendors, including members of the Intel® Embedded Alliance (intel.com/go/embeddedalliance), Intel helps to cost-effectively meet development challenges and speed time-to-market.		
Intel® Advanced Vector Extensions	Enables faster performance on digital signal image and digital signal processing workloads for compute-intensive applications such as radar detection, hurricane command center, ruggedized navigation systems and remote medical image processing.		
Intel® Turbo Boost Technology³ 2.0	Boosts performance for specific workloads by increasing processor frequency.		
Intel® HD Graphics 3000	Excellent 3D performance for a broad range of embedded applications with support for dual LVDS and hybrid multi-monitor configurations.		
Intel® Hyper-Threading Technology4	Enables simultaneous multi-threading within each processor core, up to two threads per core; reduces computational latency, making optimal use of every clock cycle.		
Intel® Smart Cache Technology	Large on-die shared Last-Level Cache reduces latency to data, improving performance and power efficiency.		
Intel® AES New Instructions (Intel® AES-NI)	New instructions added to the architecture help accelerate data encryption and decryption, and improve performance.		
Error Correcting Code memory <sup>1</sup> (select SKUs)	Detects multiple-bit memory errors; locates and corrects single-bit errors to keep the system up and running.		
Intel® Intelligent Power Technology²	Automated energy efficiency reduces power consumption.		
Intel® Quick Sync Video Technology	Speeds up video conversion, editing and sharing for embedded applications such as video surveillance.		
Automated low-power states	Adjusts system power consumption based on real-time processor loads.		
Intel® Clear Video HD Technology	Visual quality and color fidelity enhancements deliver spectacular HD media playback for embedded applications such as digital signage and gaming.		
Intel® vPro™ Technology⁵	Remote management, flexible virtualization, and enhanced security capabilities enable solutions that are trusted and cost-effective.		
Intel® Active Management Technology <sup>7</sup>	The latest remote management and maintenance capabilities enable vendors to rollback firmware image; remote host-based provisioning helps to ease provisioning of end device.		
Intel® Virtualization Technology6	Speeds the transfer of platform control and movement of data between the virtual machine monitor (VMM) and other platform agents (including guest operating systems and I/O devices). By lowering the workload on the VMM, this technology addresses many embedded system design challenges, like migrating legacy software, increasing real-time performance, and making applications more secure.		
Intel® Trusted Execution Technology®	Protects embedded devices and virtual environments against rootkit and other system level attacks. Using an industry-standard TPM 1.2 to store keys and other protected data, this portion of Intel® vPro™ technology boots the BIOS, operating system, and software into a "trusted" execution state, verifying the integrity of the virtual machine and protecting the platform from unauthorized access.		

#### Intel® Core™ i7 and Intel® Core™ i5 Processors for Embedded Computing **CORE FREQUENCY (GHz)** LAST-THERMAL **ERROR** CORRECTING **CORES/** 1 CORE LEVEL DESIGN **BASE** PROCESSOR NUMBER<sup>A</sup> **THREADS** TURBO (MAX) **PACKAGE FREQUENCY** TURBO (MAX) CACHE **POWER** CODE FCPGA988 4/8 2.1 3.0 6 MB 45 W Intel® Core™ i7-2710QE 2.9 No Intel® Core™ i7-27150E 4/8 2.1 3.0 2.9 6 MB 45 W FCBGA1023 Yes Intel® Core™ i5-2510E 2/4 2.5 3.1 3 MB FCPGA988 3.0 35 W No 2/4 2.5 3.1 Intel® Core™ i5 2515E 3.0 **3 MB** 35 W FCBGA1023 Yes

### INTEL® vPRO™ TECHNOLOGY®

PROCESSOR NUMBER <sup>△</sup>	INTEL® AES-NI	INTEL® TURBO BOOST TECHNOLOGY	INTEL® HYPER- THREADING TECHNOLOGY	INTEL® VIRTUALIZATION TECHNOLOGY	INTEL® ACTIVE MANAGEMENT TECHNOLOGY	INTEL® TRUSTED EXECUTION TECHNOLOGY
Intel® Core™ i7-2710QE	Yes	Yes	Yes	Yes	Yes	Yes
Intel® Core™ i7-2715QE	Yes	Yes	Yes	Yes	Yes	Yes
Intel® Core™ i5-2510E	Yes	Yes	Yes	Yes	Yes	Yes
Intel® Core™ i5 2515E	Yes	Yes	Yes	Yes	Yes	Yes

<sup>&</sup>lt;sup>a</sup>When paired with Intel® OM67 Express chipset.

Intel® QM67 and Intel® HM65 Express Chipsets for Embedded Computing				
PRODUCT	PRODUCT CODE	PACKAGE	FEATURES	
Intel® BD82QM67 Platform Controller Hub	BD82QM67	FCBGA 989	Supports Intel® vPro™ technology; 6 SATA ports; 14 Hi-Speed USB 2.0 ports; 8 PCI Express* I/O ports	
Intel® BD82HM65 Platform Controller Hub	BD82HM65	FCBGA 989	4 SATA ports; 12 USB ports; 6 PCI Express* I/O ports	

## Intel in Embedded and Communications: intel.com/embedded

- Intel processor numbers are not a measure of performance. Processor numbers differentiate features within each processor family, not across different processor families. See www.intel.com/products/processor\_number for details.
- 1 Error Correcting Code memory is available only on Intel® Core® processors which come in a Ball Grid Array (BGA) package and these SKUs were specifically developed by the Intel® Embedded and Communication Group.
- 2 Intel® Intelligent Power Technology requires a computer system with an enabled Intel® processor, chipset, BIOS and for some features, an operating system enabled for it. Functionality or other benefits may vary depending on hardware implementation and may require a BIOS and/or operating system update. Please check with your system vendor for details
- Requires a system with Intel® Turbo Boost Technology capability. Consult your PC manufacturer. Performance varies depending on hardware, software and system configuration. For more information, visit http://www.intel.com/ technology/turboboost.
- 4 Requires an Intel® HT Technology-enabled system, check with your PC manufacturer. Performance will vary depending on the specific hardware and software used. Not available on Intel® Core® i5-750 processor. For more information including details on which processors support HT Technology, visit http://www.intel.com/info/hyperthreading.
- 5 Intel® VPro® Technology is sophisticated and requires setup and activation. Availability of features and results will depend upon the setup and configuration of your hardware, software and IT environment. To learn more visit: http://www.intel.com/ technology/vpro.
- 6 Intel® Virtualization Technology requires a computer system with an enabled Intel® processor, BIOS, virtual machine monitor (VMM). Functionality, performance or other benefits will vary depending on hardware and software configurations. Software applications may not be compatible with all operating systems. Consult your PC manufacturer. For more information, visit http://www.intel.com/go/virtualization.
- 7 Requires activation and a system with a corporate network connection, an Intel® AMT-enabled chipset, network hardware and software. For notebooks, Intel AMT may be unavailable or limited over a host OS-based VPN, when connecting wirelessly, on battery power, sleeping, hibernating or powered off. Results dependent upon hardware, setup and configuration. For more information, visit http://www.intel.com/technology/platform-technology/intel-amt.
- 8 No computer system can provide absolute security under all conditions. Intel® Trusted Execution Technology (Intel® TXT) requires a computer system with Intel® Virtualization Technology, an Intel TXT-enabled processor, chipset, BIOS, Authenticated Code Modules and an Intel TXT-compatible measured launched environment (MLE). In addition, Intel TXT also requires the system to contain a TPM v1.s. For more information, see http://www.intel.com/technology/security
- <sup>9</sup> Drivers available at: downloadcenter.intel.com (enter chipset name)

INFORMATION IN THIS DOCUMENT IS PROVIDED IN CONNECTION WITH INTEL® PRODUCTS. NO LICENSE, EXPRESS OR IMPLIED, BY ESTOPPEL OR OTHERWISE, TO ANY INTELLECTUAL PROPERTY RIGHTS IS GRANTED BY THIS DOCUMENT. EXCEPT AS PROVIDED IN INTEL'S TERMS AND CONDITIONS OF SALE FOR SUCH PRODUCTS, INTEL ASSUMES NO LIABILITY WHATSOEVER, AND INTEL DISCLAIMS ANY EXPRESS OR IMPLIED WAR-RANTY RELATING TO SALE AND/OR USE OF INTEL PRODUCTS INCLUDING LIABILITY OR WARRANTIES RELATING TO FITNESS FOR A PARTICULAR PURPOSE. MERCHANTABILITY, OR INFRINGEMENT OF ANY PATENT. COPYRIGHT OR OTHER INTELLECTUAL PROPERTY RIGHT. UNLESS OTHERWISE AGREED IN WRITING BY INTEL, THE INTEL PRODUCTS ARE NOT DESIGNED NOR INTENDED FOR ANY APPLICATION IN WHICH THE FAILURE OF THE INTEL PRODUCT COULD CREATE A SITUATION WHERE PERSONAL INJURY OR DEATH MAY OCCUR.

Intel may make changes to specifications and product descriptions at any time, without notice. Designers must not rely on the absence or characteristics of any features or instructions marked "reserved" or "undefined." Intel reserves these for future definition and shall have no responsibility whatsoever for conflicts or incompatibilities arising from future changes to them. The information here is subject to change without notice. Do not finalize a design with this information.

The products described in this document may contain design defects or errors known as errata which may cause the product to deviate from published specifications. Current characterized errata are available on request. Contact your local Intel sales office or your distributor to obtain the latest specifications and before placing your product order. Copies of documents which have an order number and are referenced in this document, or other Intel literature, may be obtained by calling 1-800-548-4725, or by visiting Intel's Web site at www.intel.com.

Copyright © 2010 Intel Corporation. All rights reserved. Intel, the Intel logo, Core, and vPro are trademarks of Intel Corporation in the U.S. and other countries.

\*Other names and brands may be claimed as the property of others.

Printed in USA





324537-002US

